

ASSIGNMENT RECORDATION COVER SHEET

PATENTS ONLY

02-12-2004

PATENTS ONLY

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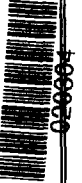
1. Name of Party(ies) conveying an interest:

William W. Sheng
Terence J. Clark
James Fain
Sylvester Karpchuk
Ronald P. Colino

2. Name and Address of Party(ies) receiving an interest:

Visteon Global Technologies, Inc.
Suite 728 Parklane Tower East
1 Parklane Blvd
Dearborn, MI 48126

22581 U.S.PTO
10/771204



Additional name(s) of conveying party(ies) attached?
 Yes No

Additional name(s) and addresses attached?
 Yes No

3. Description of the interest conveyed:

- Assignment Change of Name Other:
- Security Agreement Merger

Execution Date: 1/13/04; 1/21/04; 1/21/04; 1/28/04;
1/13/04

4. Application number(s) or patent number(s). Additional sheet attached? Yes No

If this document is being filed together with a new application, the execution date of the application is:
1/27/04; 1/21/04; 1/21/04; 1/28/04; 1/27/04

A. Patent Application No.(s)

B. Patent No.(s)

10771204

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Robert K. Fergan
BRINKS HOFER GILSON & LIONE
P.O. BOX 10395
CHICAGO, IL 60610

6. Number of applications and patents involved: 1

7. Total fee (37 CFR 3.41) \$ 40.00

- Enclosed
- Authorized to be charged to Deposit Account No. 06-1500 (VISTEON GLOBAL TECHNOLOGIES, INC.)
- Please charge any deficiencies in fee or credit any overpayment to Deposit Account No. 06-1500.

DO NOT USE THIS SPACE

02/11/2004 LMUELLER 00000097 061500 10771204

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Robert K. Fergan
Name of Person Signing

Signature

February 3, 2004
Date

Total number of pages including cover sheet, attachments, and document: 4

BRINKS
HOFER
GILSON
& LIONE
BRINKS HOFER GILSON & LIONE
PO Box 10395
Chicago, IL 60611-5599

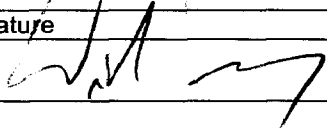
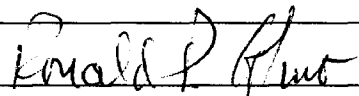
ASSIGNMENT

WHEREAS, we have invented: SILICON NITRIDE INSULATING SUBSTRATE FOR POWER SEMICONDUCTOR MODULE, identified as Visteon Disclosure No.: V202-0793 and Attorney Docket No.: 10541-1811, and described in the application executed on the same date hereof.

WHEREAS, VISTEON GLOBAL TECHNOLOGIES, INC., a corporation organized under the laws of the State of Michigan and located at Suite 728, Parklane Towers East, One Parklane Boulevard, Dearborn, Michigan 48126, is desirous of acquiring an exclusive right to said invention.

For valuable consideration, receipt of which is hereby acknowledged, we hereby sell and assign to VISTEON GLOBAL TECHNOLOGIES, INC., the full and exclusive right to said invention, to all patent applications for said invention in the United States and in all other countries, including all rights of priority in and to said invention in such other countries, and to all patents issued on said invention in the United States and in all other countries; and we hereby request the Director of the United States Patent and Trademark Office to issue all patents on said invention to VISTEON GLOBAL TECHNOLOGIES, INC, as the assignee.

Executed by:

Name	Signature	Date
William W. Sheng		1/13/04
Terence J. Clark		
James Fain		
Sylvester Karpchuk		
Ronald P. Colino		1/13/04

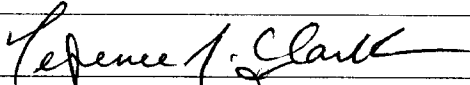
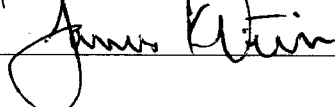
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Executed by:

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Name	Signature	Date
William W. Sheng		
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James Fain		
Sylvester Karpchuk		1-28-04
Ronald P. Colino		